

# PS9324L, PS9324L2

R08DS0060EJ0100 Rev.1.00

HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE, 6-PIN SDIP PHOTOCOUPLER

Apr 26, 2013

### **DESCRIPTION**

The PS9324L and PS9324L2 are optical coupled high-speed, active low type isolators containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9324L is lead bending type (Gull-wing) for surface mounting.

The PS9324L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

### **FEATURES**

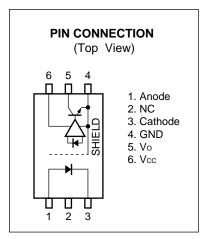
- High common mode transient immunity (CM<sub>H</sub>, CM<sub>L</sub> =  $\pm 15$  kV/ $\mu$ s MIN.)
- Half size of 8-pin DIP
- Long creepage distance (8 mm MIN.: PS9324L2)
- High-speed (10 Mbps)
- High-speed response ( $t_{PHL} = 75 \text{ ns MAX.}, t_{PLH} = 75 \text{ ns MAX.}$ )
- Low power consumption ( $V_{CC} = 3.3/5 \text{ V}$ )
- Open collector output
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Embossed tape product: PS9324L-E3: 2 000 pcs/reel

: PS9324L2-E3: 2 000 pcs/reel

- Pb-Free product
- Safety standards
  - UL approved: No. E72422
  - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
  - SEMKO approved (EN 60065, EN 60950)
  - DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

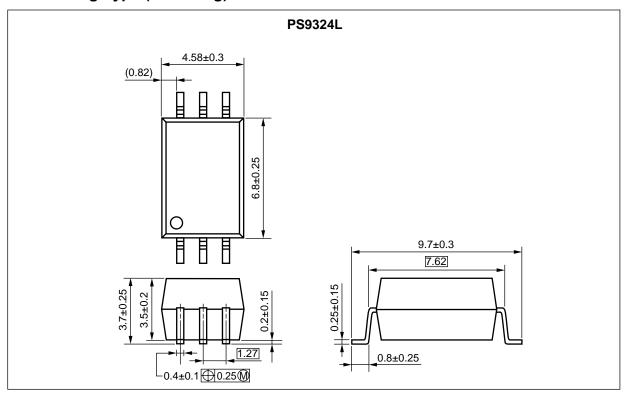
### **APPLICATIONS**

- Measurement equipment
- PDP
- FA Network

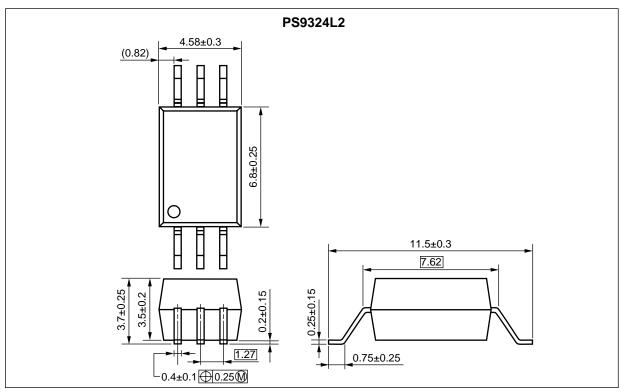


## PACKAGE DIMENSIONS (UNIT: mm)

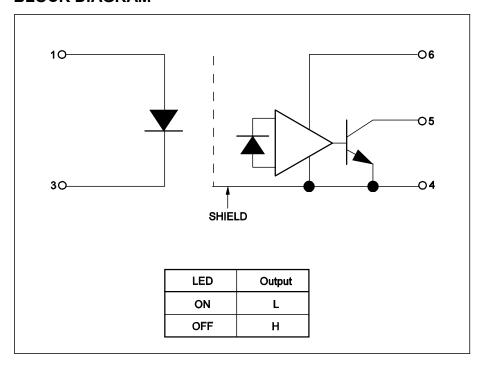
## Lead Bending Type (Gull-wing) For Surface Mount



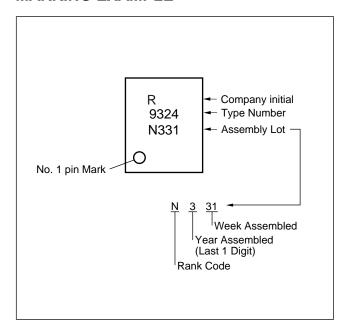
## Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



### **BLOCK DIAGRAM**



### **MARKING EXAMPLE**



### PHOTOCOUPLER CONSTRUCTION

Parameter	PS9324L	PS9324L2
Air Distance (MIN.)	7 mm	8 mm
Outer Creepage Distance (MIN.)	7 mm	8 mm
Isolation Distance (MIN.)	0.4 mm	0.4 mm

### **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS9324L	PS9324L-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9324L
PS9324L-E3	PS9324L-E3-AX	(Ni/Pd/Au)	Embossed Tape 2 000	UL, CSA ,SEMKO	
			pcs/reel	approval)	
PS9324L2	PS9324L2-AX		20 pcs (Tape 20 pcs cut)	Standard products	PS9324L2
PS9324L2-E3	PS9324L2-E3-AX		Embossed Tape 2 000	UL, CSA ,SEMKO	
			pcs/reel	approval)	
PS9324L-V	PS9324L-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN 60747-5-5	PS9324L
PS9324L-V-E3	PS9324L-V-E3-AX		Embossed Tape 2 000	(VDE 0884-5)	
			pcs/reel	Approved (Option)	
PS9324L2-V	PS9324L2-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN 60747-5-5	PS9324L2
PS9324L2-V-E3	PS9324L2-V-E3-AX		Embossed Tape 2 000	(VDE 0884-5)	
			pcs/reel	Approved (Option)	

Note: \*1. For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current *1	I <sub>F</sub>	25	mA
	Reverse Voltage	$V_R$	5	V
Detector	Supply Voltage	$V_{CC}$	7	V
	Output Voltage	Vo	7	V
	Output Current	Io	25	mA
	Power Dissipation *2	Pc	200	mW
Isolation Voltage *3		BV	5 000	Vr.m.s.
Operating Ambient Temperature		T <sub>A</sub>	-40 to +110	°C
Storage T	emperature	$T_{stg}$	-55 to +125	°C

Notes: \*1. Reduced to 0.2 mA/°C at  $T_A = 25$ °C or more.

### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Current	$V_{FL}$	0		0.8	V
High Level Input Current	I <sub>FH</sub>	3.8	6	7.5	mA
Supply Voltage	V <sub>CC</sub>	2.7		5.5	V
TTL ( $R_L = 1 \text{ k}\Omega$ , loads)	N			5	
Pull-up Resistor	RL	330		4k	Ω

<sup>\*2.</sup> Reduced to 4.0 mW/ $^{\circ}$ C at T<sub>A</sub> = 75 $^{\circ}$ C or more.

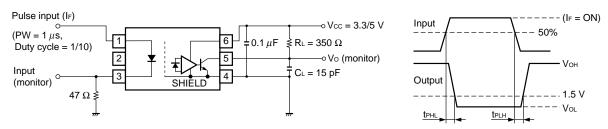
<sup>\*3</sup> AC voltage for 1 minute at  $T_A$  = 25°C, RH = 60% between input and output. Pins 1-3 shorted together, 4-6 shorted together.

## ELECTRICAL CHARACTERISTICS ( $T_A = -40$ to +110°C, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA, T <sub>A</sub> = 25°C	1.3	1.55	1.8	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 3 V, T <sub>A</sub> = 25°C			10	μΑ
	Terminal Capacitance	Ct	f = 1 MHz, V <sub>F</sub> = 0 V, T <sub>A</sub> = 25°C		30		pF
Detector	High Level Output Current	lон	$V_{CC} = V_O = 3.3 \text{ V}, V_F = 0.8 \text{ V}$		1	80	μA
			$V_{CC} = V_O = 5.5 \text{ V}, V_F = 0.8 \text{ V}$		1	100	,
	Low Level Output Voltage	$V_{OL}$	$V_{CC} = 3.3 \text{ V}, I_F = 4.5 \text{ mA},$		0.2	0.6	V
			I <sub>OL</sub> = 13 mA				
			$V_{CC} = 5.5 \text{ V}, I_F = 4.5 \text{ mA},$				
			I <sub>OL</sub> = 13 mA				
	High Level Supply Current	I <sub>CCH</sub>	$V_{CC} = 3.3 \text{ V}, I_F = 0 \text{ mA},$		4	7	mA
			V <sub>O</sub> = open				
			$V_{CC} = 5.5 \text{ V}, I_F = 0 \text{ mA},$				
			V <sub>O</sub> = open				
	Low Level Supply Current	I <sub>CCL</sub>	$V_{CC} = 3.3 \text{ V}, I_F = 4.5 \text{ mA},$		6	10	mA
			V <sub>O</sub> = open		_		
			$V_{CC} = 5.5 \text{ V}, I_F = 4.5 \text{ mA},$		7	10	
0 1 1	<del>-</del>		V <sub>O</sub> = open			•	
Coupled	Threshold Input Voltage	I <sub>FHL</sub>	$V_{CC} = 3.3 \text{ V}, R_L = 350 \Omega,$		1	3	mA
	$(H \rightarrow L)$		$V_0 = 0.8 \text{ V}$				
			$V_{CC} = 5.0 \text{ V}, R_L = 350 \Omega,$				
	Inclation Projetance	D	$V_O = 0.8 \text{ V}$ $V_{I-O} = 1 \text{ kV}_{DC}, \text{ RH} = 40 \text{ to } 60\%$	10 <sup>11</sup>			0
	Isolation Resistance Isolation Capacitance	R <sub>I-O</sub>	$V_{I-O} = 0 \text{ V, } f = 1 \text{ MHz,}$	10	0.6		Ω pF
	Isolation Capacitance	OI-0	$T_A = 25^{\circ}C$		0.0		ρı
	Propagation Delay Time	t <sub>PHL</sub>	T <sub>A</sub> = 25°C		40	75	ns
	$(H \rightarrow L)^{*2}$	YPHL	$V_{CC} = 3.3 \text{ V, I}_{F} = 4.5 \text{ mA,}$		10	100	110
	( / _/		$R_L = 350 \Omega, C_L = 15 pF$			100	
			T <sub>A</sub> = 25°C		40	75	
			$V_{CC} = 5 \text{ V}, I_F = 4.5 \text{ mA},$			100	
			$R_L = 350 \Omega$ , $C_L = 15 pF$				
	Propagation Delay Time	t <sub>PLH</sub>	T <sub>A</sub> = 25°C		50	75	ns
	$(L \rightarrow H)^{*2}$		$V_{CC} = 3.3 \text{ V, I}_{E} = 4.5 \text{ mA,}$			100	
	(- / )		$R_L = 350 \Omega$ , $C_L = 15 pF$			. • •	
			T <sub>A</sub> = 25°C		45	75	
			$V_{CC} = 5 \text{ V}, I_F = 4.5 \text{ mA},$			100	
			$R_L = 350 \Omega, C_L = 15 pF$				
	Pulse Width Distortion	t <sub>PHL-</sub> t <sub>PLH</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 4.5 \text{ mA},$		5	35	ns
	(PWD)*2		$R_L = 350 \Omega, C_L = 15 pF$				
	Propagation Delay Skew*2	t <sub>psk</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 4.5 \text{ mA},$			40	ns
			$R_L = 350 \Omega, C_L = 15 pF$				
	Rise Time*3	t <sub>r</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 4.5 \text{ mA},$		20		ns
			$R_L = 350 \Omega, C_L = 15 pF$				
	Fall Time*3	t <sub>f</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 4.5 \text{ mA},$		5		ns
			$R_L = 350 \Omega, C_L = 15 pF$				
	Common Mode	CM <sub>H</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 0 \text{ mA},$	15	20		kV/ <i>μ</i> s
	Transient Immunity at		$V_0 > 2 V, R_L = 350 \Omega,$				
	High Level Output*4	lari	V <sub>CM</sub> = 1.5 kV, T <sub>A</sub> = 25°C	4-			
	Common Mode	CM <sub>L</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 4.5 \text{ mA},$	15	20		kV/ <i>μ</i> s
	Transient Immunity at Low		$V_0 < 0.8 \text{ V}, R_L = 350 \Omega,$				
	Level Output*4		$V_{CM} = 1.5 \text{ kV}, T_A = 25^{\circ}\text{C}$				

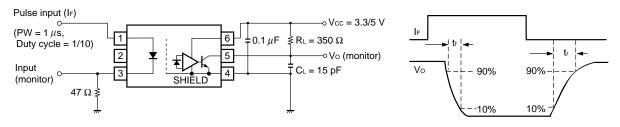
### Notes: \*1. Typical values at T<sub>A</sub> = 25°C

### \*2. Test circuit for propagation delay time



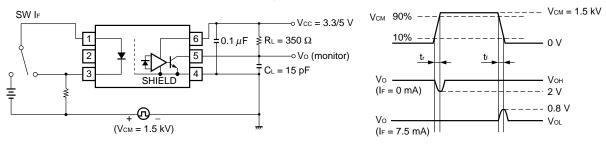
Remark C<sub>L</sub> includes probe and stray wiring capacitance.

### \*3. Test circuit for switching time



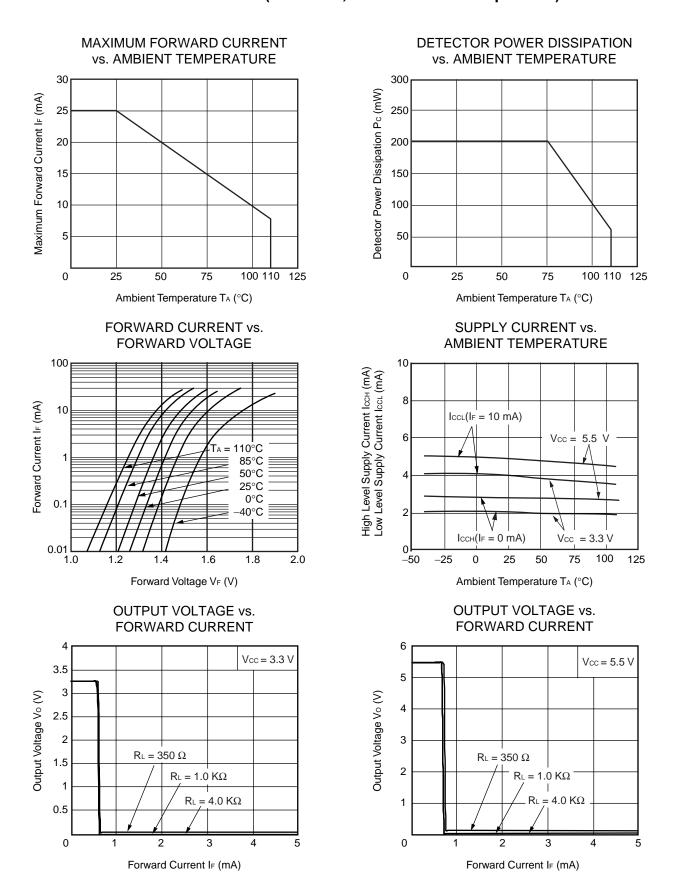
 $\textbf{Remark} \quad C_L \text{ includes probe and stray wiring capacitance}.$ 

### \*4. Test circuit for common mode transient immunity



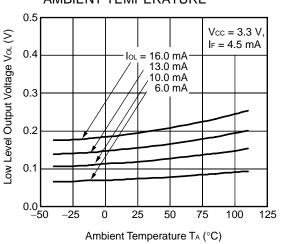
Remark C<sub>L</sub> includes probe and stray wiring capacitance.

### TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

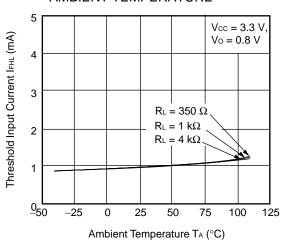


**Remark** The graphs indicate nominal characteristics.

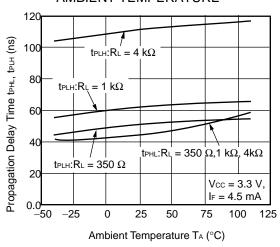
# LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



# THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

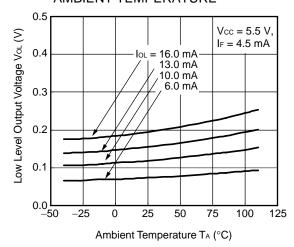


## PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE

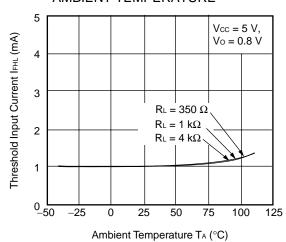


Remark The graphs indicate nominal characteristics.

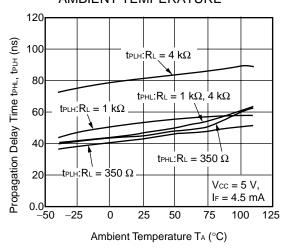
# LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



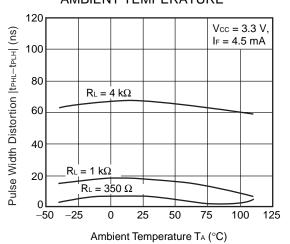
# THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



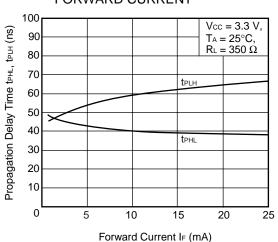
# PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



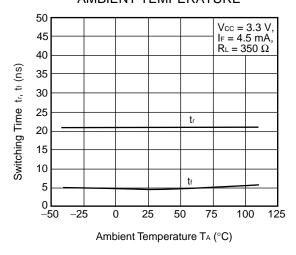
# PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



# PROPAGATION DELAY TIME vs. FORWARD CURRENT

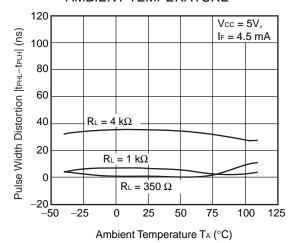


# SWITCHING TIME vs. AMBIENT TEMPERATURE

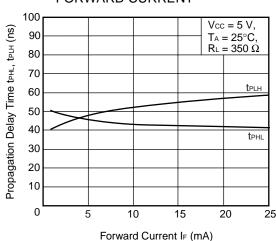


Remark The graphs indicate nominal characteristics.

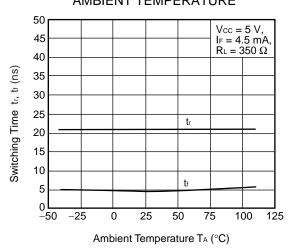
## PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



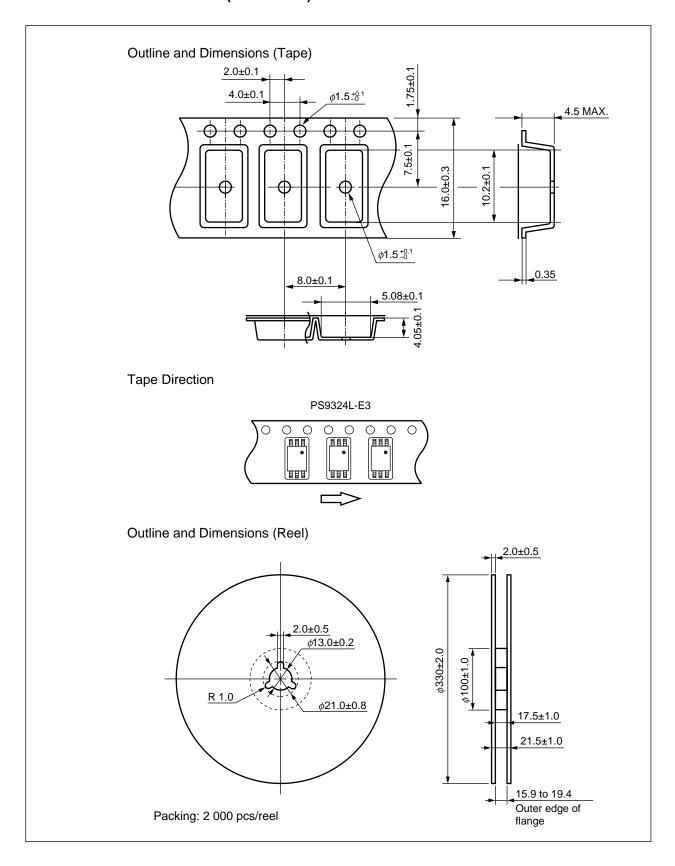
# PROPAGATION DELAY TIME vs. FORWARD CURRENT

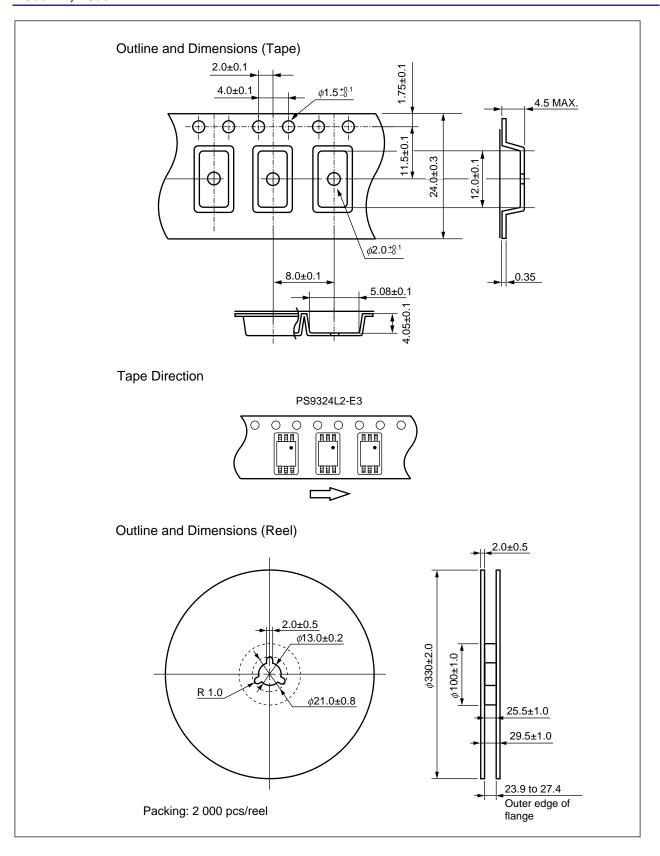


## SWITCHING TIME vs. AMBIENT TEMPERATURE

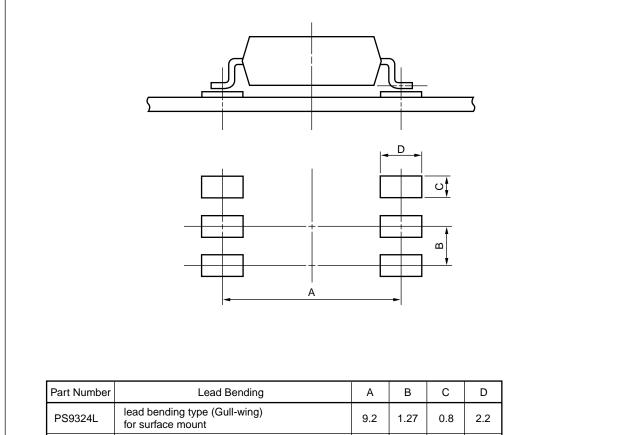


## TAPING SPECIFICATIONS (UNIT: mm)





### RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Part Number	Lead Bending	А	В	С	D
PS9324L	lead bending type (Gull-wing) for surface mount	9.2	1.27	0.8	2.2
PS9324L2	lead bending type (Gull-wing) for long creepage distance (surface mount)	10.2	1.27	0.8	2.2

### **NOTES ON HANDLING**

### 1. Recommended soldering conditions

### (1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

Time of peak reflow temperature
 Time of temperature higher than 220°C
 10 seconds or less
 60 seconds or less

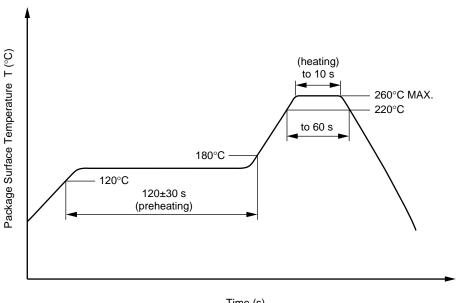
• Time to preheat temperature from 120 to 180°C 120±30 s

Number of reflows
 Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



Time (s)

### (2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

Number of times
 One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content

of 0.2 Wt% is recommended.)

### (3) Soldering by soldering iron

Peak temperature (lead part temperature) 350°C or below
 Time (each pin) 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collectoremitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

### **USAGE CAUTIONS**

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than  $0.1 \,\mu\text{F}$  is used between  $V_{CC}$  and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. When V<sub>DD</sub> is lower than around 2 V, the output(V<sub>O</sub>) of this product is unstable, and this might produce undesirable operation. Be sure to check the operation of an IC or a discrete component that is connected to this product during Power-up and Power-down process. And we recommend to use a disable function (shutdown function) of the connected IC or a reset IC to avoid this undesirable operation.
- **4.** Pin 2 (which is an NC<sup>\*1</sup> pin) can either be connected directly to the GND pin on the LED side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.
  - Note: \*1. NC: Non-Connection (No Connection).
- 5. Avoid storage at a high temperature and high humidity.

## SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/110/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{\text{IORM}},  P_{\text{d}} < 5  \text{pC}$	Uiorm Upr	1 130 1 808	V <sub>peak</sub> V <sub>peak</sub>
Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM},  P_d < 5 \; pC$	Upr	2 119	V <sub>peak</sub>
Highest permissible overvoltage	Utr	8 000	Vpeak
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	СТІ	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-40 to +110	°C
Isolation resistance, minimum value $V_{IO}$ = 500 V dc at $T_A$ = 25°C $V_{IO}$ = 500 V dc at $T_A$ MAX. at least 100°C	Ris MIN. Ris MIN.	10 <sup>12</sup> 10 <sup>11</sup>	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I <sub>F</sub> , Psi = 0) Power (output or total power dissipation) Isolation resistance	Tsi Isi Psi	175 400 700	°C mA mW
V <sub>IO</sub> = 500 V dc at T <sub>A</sub> = Tsi	Ris MIN.	10 <sup>9</sup>	Ω

### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

**Revision History** 

## PS9324L, PS9324L2 Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Apr 26, 2013	_	First Edition Issued	

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